

View Online at https://aerobasegroup.com/nsn/5910-01-276-2246

Body Style:	
Chip type	
Reliability Indicator:	
Established	
Reliability Failure Rate Level In Percent:	
0.010	
Terminal Length:	
Between 0.005 inches and 0.025 inches	
Body Length:	
Between 0.090 inches and 0.145 inches	
Body Width:	
Between 0.090 inches and 0.130 inches	
Body Height:	
Between 0.030 inches and 0.102 inches	
Schematic Diagram Designator:	
No common or grounded electrode (s)	
Insulation Resistance At Maximum Operating Temp:	
100000.0 megohms	
Capacitance Value Per Section:	
1.000 picofarads single section	
Nonderated Operating Temp:	
Between -55.0 degrees celsius and 125.0 degrees celsius	
Tempurature Coefficient Of Capacitance Per Section In Ppm Per Deg Celsius:	
90.0 single section	
Nonderated Continuous Voltage Rating And Type Per Section:	
500.0 dc single section	
Tolerance Of Tempurature Coefficient Per Section In Ppm Per Deg Celsius:	
-20.0/+20.0 single section	
Tolerance Range Per Section:	
-0.10/+0.10 picofarads single section	
Case Material:	
Ceramic or glass	
Insulation Resistance At Reference Temp:	
100000.0 megohms	
Dissipation Factor At Reference Tempurature In Percent:	
0.050	
Quality Factor At Reference Temp:	
100000.000	
Terminal Surface Treatment:	
Solder	
Test Data Document:	
81349-mil-c-55681 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification	
format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain	

environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).



Terminal Type And Quantity:

2 bonding pad

Specification Data:

81349-mil-c-55681/4 government specification

Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

No

Fiig:

A010b0